BGA622L7

Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

Small Signal Discretes



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BGA622L7, Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

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Previous Version: 2006-05-19

Page Subjects (major changes since last revision)

All Document layout change

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1 Silicon Germanium Wide Band Low Noise Amplifier with 2 kV ESD Protection

Feature

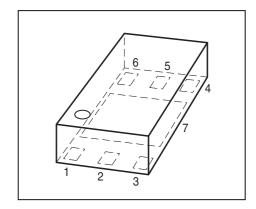
High gain

 $|S_{21}|^2$ = 17.5 dB at 1.575 GHz

 $|S_{21}|^2$ = 16.8 dB at 1.9 GHz

 $|S_{21}|^2$ = 16.2 dB at 2.14 GHz

- Low noise figure, NF = 0.95 dB at 1.575 GHz
- Operating frequency range 0.5 6 GHz
- Typical supply voltage: 2.75 V
- On/Off-Switch
- · Output-match on chip, input pre-matched
- Low external part count
- Tiny TSLP-7-1 leadless package
- 70 GHz f_T Silicon Germanium technology
- 2 kV HBM ESD protection (Pin-to-Pin)
- Pb-free (RoHS compliant) package



TSLP-7-1



Applications

LNA for GSM, GPS, DCS, PCS, UMTS, Bluethooth, ISM and WLAN

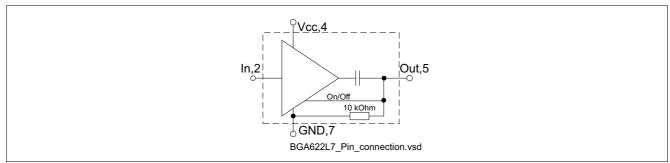


Figure 1 Pin connection

Description

The BGA622L7 is a wide band low noise amplifier, based on Infineon Technologies' Silicon Germanium Technology B7HF. The out-pin is simultaneously used for RF out and On/Off switch. This functionality can be accessed using a RF-Choke at the Out pin, where a DC level of 0 V or an open switches the device on and a DC level of $V_{\rm CC}$ switches off, it provides an insertion loss of 26 dB together with a high IIP_3 up to 24 dBm at GPS frequencies.

Туре	Package	Marking		
BGA622L7	TSLP-7-1	BX		

Note: **ESD:** Electrostatic discharge sensitive device, observe handling precaution



Maximum Ratings

2 Maximum Ratings

Table 1 Maximum ratings

Parameter	Symbol	Limit Value	Unit	
Voltage at pin $V_{\rm CC}$	$V_{\sf CC}$	3.5	V	
Voltage at pin Out	V_{out}	4	V	
Current into pin In	I_{in}	0.1	mA	
Current into pin Out	I_{out}	1	mA	
Current into pin $V_{\rm CC}$	I_{Vcc}	10	mA	
RF input power	P_{in}	6	dBm	
Total power dissipation, T_S < 142 °C ¹⁾	P_{tot}	35	mW	
Junction temperature	T_{J}	150	°C	
Ambient temperature range	T_{A}	-65 150	°C	
Storage temperature range	T_{STG}	-65 150	°C	
ESD capability all pins (HBM: JESD22-A114)	V_{ESD}	2000	V	

¹⁾ $T_{\rm S}$ is measured on the ground lead at the soldering point

Note: All Voltages refer to GND-Node

Thermal resistance

Table 2 Thermal resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R_{thJS}	240	K/W

¹⁾ For calculation of R_{thJA} please refer to Application Note Thermal Resistance

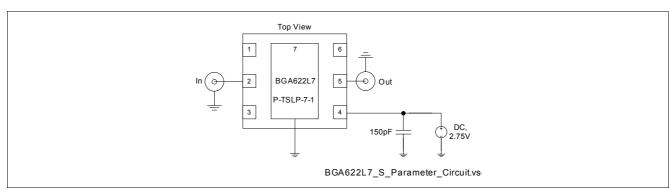


Figure 2 S-Parameter Test Circuit (loss-free microstrip line)



Electrical Characteristics

3 Electrical Characteristics

3.1 Electrical Characteristics at $T_{\rm A}$ = 25 °C (measured according to Figure 2) $V_{\rm CC}$ = 2.75 V, Frequency = 1.575 GHz, unless otherwise specified

Table 3 Electrical Characteristics

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Insertion power gain	$ S_{21} ^2$		17.5		dB	
Insertion power gain (Off-State)	$ S_{21} ^2$		-26		dB	
Input return loss (On-State)	$RL_{\sf in}$		5		dB	
Output return loss (On-State)	RL_{out}		12		dB	
Noise figure ($Z_{\rm S}$ = 50 Ω)	$F_{50\Omega}$		0.95		dB	
Input third order intercept point ¹⁾ (On-State)	IIP_3		-2		dBm	Δf = 1 MHz, P_{IN} = -28 dBm
Input third order intercept point ¹⁾ (Off - State)	IIP_3		24		dBm	Δf = 1 MHz, P_{IN} = -8 dBm
Input power at 1 dB gain compression	$P_{ ext{-1dB}}$		-20		dBm	
Total device off current	$I_{tot\text{-off}}$		260		μΑ	$V_{\rm CC}$ = 2.75 V, $V_{\rm out}$ = $V_{\rm CC}$
Total device on current	$I_{tot ext{-on}}$		5.8		mA	$V_{\rm CC}$ = 2.75 V
On / Off switch control voltage	V_{on}	0		0.8	V	$V_{\rm CC}$ = 2.75 V ON-Mode: $V_{\rm out}$ = $V_{\rm on}$
	$V_{ m off}$	2.0		3.5	V	$V_{\rm CC}$ = 2.75 V OFF-Mode: $V_{\rm out}$ = $V_{\rm off}$

¹⁾ IP_3 values depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.1 to 6 GHz



Electrical Characteristics

3.2 Electrical Characteristics at $T_{\rm A}$ = 25 °C (measured according to Figure 2) $V_{\rm CC}$ = 2.75 V, Frequency = 2.14 GHz, unless otherwise specified

Table 4 Electrical Characteristics

Parameter	Symbol	Values			Unit	Note /
		Min.	Тур.	Max.		Test Condition
Insertion power gain	$ S_{21} ^2$		16.2		dB	
Insertion power gain (Off-State)	$ S_{21} ^2$		-23		dB	
Input return loss (On-State)	$RL_{\sf in}$		6		dB	
Output return loss (On-State)	RL_{out}		12		dB	
Noise figure ($Z_{\rm S}$ = 50 Ω)	$F_{50\Omega}$		1.05		dB	
Input third order intercept point ¹⁾ (On-State)	IIP_3		0		dBm	Δf = 1 MHz, P_{IN} = -28 dBm
Input third order intercept point ¹⁾ (Off-State)	IIP_3		22		dBm	Δf = 1 MHz, P_{IN} = -8 dBm
Input power at 1 dB gain compression	$P_{ ext{-1dB}}$		-16		dBm	

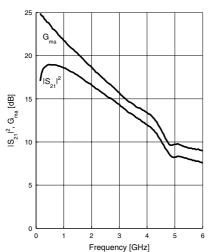
¹⁾ IP_3 values depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.1 to 6 GHz



Measured Parameters

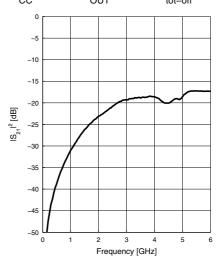
4 Measured Parameters

Power Gain
$$|S_{21}|^2$$
, $G_{ma} = f(f)$
 $V_{CC} = 2.75V$, $I_{tot-on} = 5.8mA$



Off Gain
$$IS_{21}^{2}I^{2} = f(f)$$

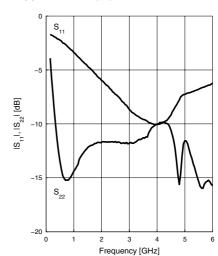
 $V_{CC} = 2.75V, V_{OUT} = 2.75V, I_{tot-off} = 0.3mA$



Reverse Isolation
$$|S_{12}| = f(f)$$

 $V_{CC} = 2.75V$, $I_{tot-on} = 5.8mA$

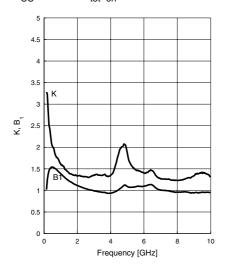
$$\begin{aligned} & \textbf{Matching} \ |S_{11}|, \ |S_{22}| = f(f) \\ & V_{CC} = 2.75V, \ I_{tot-on} = 5.8 \text{mA} \end{aligned}$$





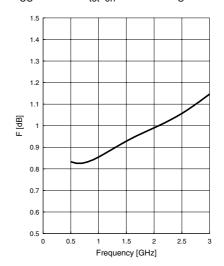
Measured Parameters

Stability K, B₁ = f(f)
$$V_{CC} = 2.75V$$
, $I_{tot-on} = 5.8mA$



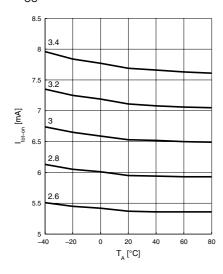
Noise Figure F = f(f)

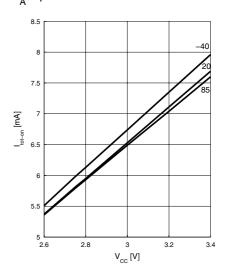
$$V_{CC} = 2.75V$$
, $I_{tot-on} = 5.8mA$, $Z_{S} = 50\Omega$



Device Current I
$$_{tot-on} = f(T_A, V_{CC})$$

V $_{CC} = parameter in V$







Package Information

5 Package Information

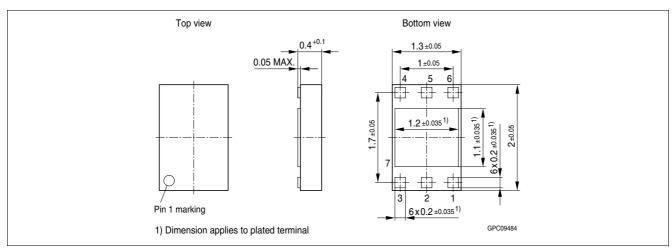


Figure 3 Package Outline TSLP-7-1

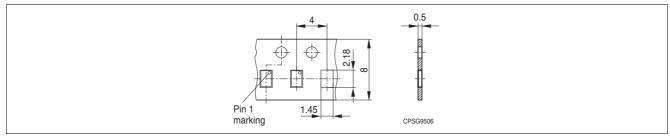


Figure 4 Tape for TSLP-7-1

单击下面可查看定价,库存,交付和生命周期等信息

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